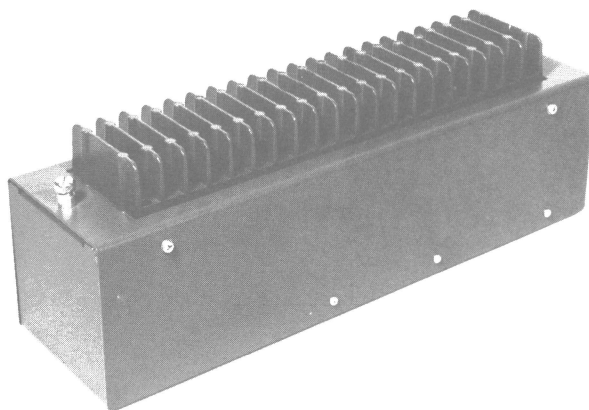




# POWR MASTR

150.8 - 174 MHz, 60 WATT  
VEHICULAR POWER AMPLIFIER  
TYPE KT-183-A



## SPECIFICATIONS \*

Dimensions (H x W x D)	5.2" x 14.5" x 4" (13.2 cm x 36.8 cm x 10.1 cm)
Weight	8 pounds (3.63 Kilograms)
DC Input Voltage	13.6 VDC
RF Drive	1 to 6 Watts
Current Drain	
Standby	40 Milliamps
Transmit	13.5 Amps (rated power)
Temperature Range	-30°C to 60°C
Receiver Insertion Loss	0.75 dB
Spurious	
Radiated	-60 dB
Conducted	-60 dB

\*These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

## TABLE OF CONTENTS

	<u>Page</u>
SPECIFICATIONS .....	Cover
COMBINATION NOMENCLATURE .....	ii
DESCRIPTION .....	1
CIRCUIT ANALYSIS .....	1
INSTALLATION INSTRUCTIONS .....	3
MAINTENANCE	
Disassembly Procedure .....	4
Adjustment Procedure .....	5
Troubleshooting Procedure .....	6
INTERCONNECTION DIAGRAM .....	7
OUTLINE DIAGRAMS .....	9-10
SCHEMATIC DIAGRAMS	
Interface Board .....	11
Power Amplifier .....	12
PARTS LIST .....	13
PRODUCTION CHANGES .....	15

## COMBINATION NOMENCLATURE

1, 2 Digits	3rd Digit	7th Digit	5th Digit	6th Digit	4th Digit
Product Code	Package	Frequency Range	RF Power	Control	Power Source
<b>P3</b>	<b>A</b> Basic	<b>K</b> 150.8-174 MHz	<b>6</b> 41-80 Watts	<b>A</b> Standard	<b>G</b> 12 Volt DC Neg Grd

## DESCRIPTION

General Electric POWR MASTR Vehicular Power Amplifier, Type KT-183-A is used in conjunction with the appropriate vehicular charger to increase the transmit power of a personal radio to 60 watts in the 150.8 to 174 MHz frequency range.

The vehicular power amplifier consists of a control circuit and preamplifier, and an RF power amplifier (PA). The preamplifier accommodates various input power levels of 1 - 6 watts and delivers a constant output power to drive the power amplifier. The control circuit senses the input drive from the mobile charger and controls the antenna relay and solid state switch. Both the control circuit and the preamplifier are contained on a single printed wire interface board. The printed wire interface board is mounted inside a hinged cover to provide easy access to the board for servicing. The hinged cover also provides easy access to the power amplifier, low pass filter and centralized metering jack J5.

The Vehicular Power Amplifier requires no tuning. There are only two adjustments to be made; the input level adjustment with R2 on the interface board and the power output adjust with R8 on the final power amplifier board. The input level adjust sets the drive power level required to activate the final power amplifier. The power output adjust sets the output power level.

Since no output tuning is provided, antennas must match 50 ohms within a 1.4:1 VSWR or more than 10% power loss will result. Antenna matching is important.

The PA assembly uses three RF power transistors to provide a power output of 60 watts. The output power is adjustable using power control potentiometer R8 over a range of 20 to 60 watts. A single transistor is used in the power control circuit.

Supply voltage for the PA is connected through feed-through-capacitors C297 and C298 on the side of the PA assembly. C297, C298, C299, L12 and L13 prevent RF from getting on the power leads. Diode CR295 will cause the main fuse in the fuse assembly to blow if the polarity of the power leads is reversed, providing reverse voltage protection for the amplifier.

Centralized metering jack J5 is provided for use with GE Test Set Model 4EX3A11 or Test Kit 4EX8K12. The Test Set meters the Ampl-1 drive, Ampl-1, Driver and PA current.

## CIRCUIT ANALYSIS

### INTERFACE BOARD

The interface board consists of a voltage regulator circuit, control circuit and

an RF preamplifier circuit. The 13.6 VDC vehicular battery voltage is connected to J102 of the vehicular power amplifier. This DC power input is connected to both the final RF power amplifier and across H1 and G10 on the interface board. The DC voltage on H1 is applied to the collector of NPN pass transistor Q2. Zener diode VR1 controls the base of Q2 to regulate the output on the emitter to 10.5 volts. The 10.5 regulated volts powers the control circuit and the RF preamplifier.

### Control Circuit

The control circuit consist of an RF detector and switching circuit and a PIN diode RF switch. RF detector CR1 detects RF drive from the vehicular charger to operate solid state switching circuit U1 and activate the antenna relay. Level adjust R2 sets the RF level where U1 will switch (1 to 6 watts).

PIN diode RF switch, consisting of CR3, CR4 and CR5, is turned on only in the transmit mode. When on, RF is routed through the preamplifier and power amplifier to the antenna. When in the receive mode, and the switch is off, the receiver is isolated from the preamplifier. Any received signal is routed from the antenna to the vehicular charger.

The RF output of the RF switch, when in the transmit mode, is routed through thick film attenuator AT1. AT1 is used to decrease the drive to a suitable level for the preamplifier circuit.

### RF Preamplifier

The RF Preamplifier consists of RF power transistor Q1 and associated circuitry. The preamplifier amplifies the RF from attenuator AT1 to a leveled output of 250 to 450 milliwatts to drive the final power amplifier.

### POWER AMPLIFIER

The power amplifier consists of PA driver A201, PA A202 and Low Pass Filter F202.

### PA Driver (A201)

The Preamplifier output is coupled through an RF cable to PA input jack J1. The RF is coupled through a matching network to the base of Class C amplifier Q201. The network matches the 50 ohm input to the base of Q201, and consists of T1, C4 and L2. L1, R3 and C3 comprise a stabilizing network in the base circuit of Q201.

Part of the RF input is rectified by CR1 and applied to voltage divider R1 and R2. This voltage is used to meter the Ampl-1 drive at J5.

Collector voltage of Q201 (Ampl-1) is controlled by power control transistor Q215 and is applied through a collector stabilizing and feed network consisting of C6, L3, L4 and R4. The collector voltage of Q201 is metered through R7 and J5.

The output of Q201 is coupled to the base of Class C driver Q202 through a matching network consisting of L5, L6, C12, C13, C14 and R5. Collector voltage to Q202 is applied through collector stabilizing and feed network C15, L8, L11 and R6.

Collector current for Q202 is metered across tapped manganin resistor R9 at J5 (Driver Current). The reading is taken on the one-volt scale with the high sensitivity button pressed, and read as 10 amperes full scale.

The driver output is coupled through a matching network (C19, C20, C21, L9 and L10) and applied to the PA board (A202) through W217.

Capacitors C30 through C34 provide isolation for positive and negative ground operation. C22 provides DC isolation between the Driver board and the PA board.

#### PA Board (A202)

The driver output is coupled to the base of Class C Power Amplifier Q1 through a matching network consisting of C1 through C4, L1 and L2. L7 provides the DC return for the base of Q1. Collector voltage for Q1 is coupled through stabilizing network Z1 and collector feed network C10 and L6.

Collector current for Q1 is metered across tapped manganin resistor R10. The reading is taken on the one-volt scale with the High Sensitivity button pressed, and read as 10 amperes full scale.

Following Q1 is a matching network (C5, C6, C7, C9, L3, L4 and L5) that matches the output of Q1 to the 50 ohm input impedance of microstrip W1 on the low pass filter.

The PA output is coupled through the low pass filter to the antenna through the antenna transfer relay.

Capacitor C14 through C20 provide DC ground isolation for positive and negative ground operation. C8 provides DC isolation between the PA board and the antenna.

#### WARNING

The RF Power Transistors used in the Vehicular Power Amplifier contain Beryllium Oxide, a TOXIC substance. If the ceramic or other encapsulation is opened, crushed, broken or abraded, the dust may be hazardous if inhaled. Use care in replacing transistors of this type.

#### Power Adjust Circuit

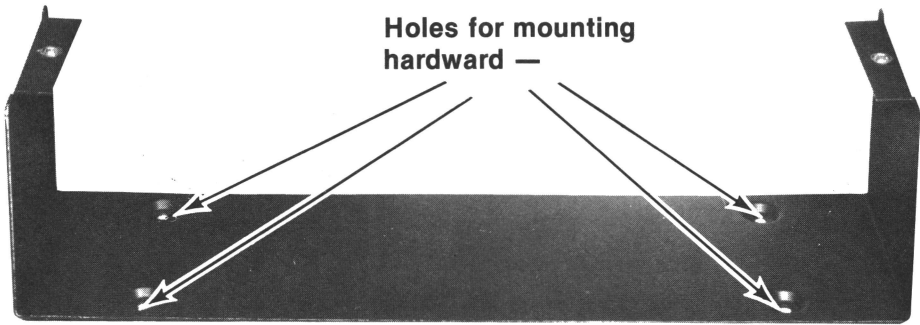
The Power adjust circuit consists of R8 and Q215. R8 controls the base voltage and conduction of Q215. Q215 is connected in series with the collector feed network for Q201, thereby controlling the drive to Q202 and the output power. R8 is adjusted to provide the desired output power.

GENERAL ELECTRIC COMPANY • MOBILE COMMUNICATIONS DIVISION  
WORLD HEADQUARTERS • LYNCHBURG, VIRGINIA 24502 U.S.A.

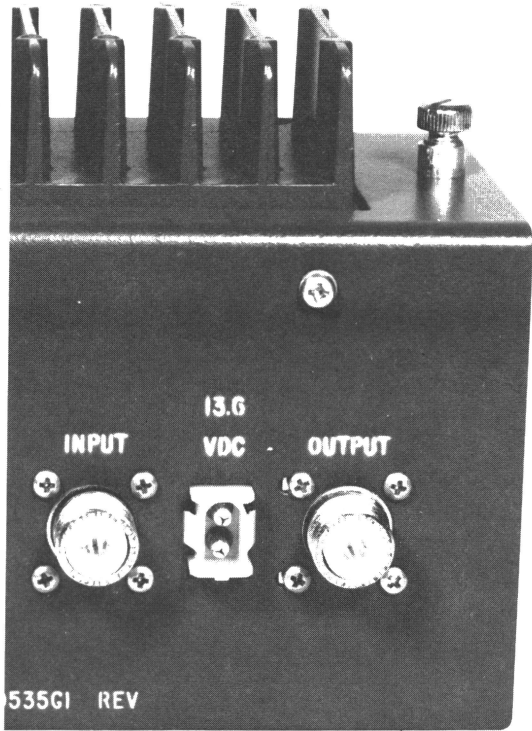
**GENERAL  ELECTRIC\***  
U.S.A.

INSTALLATION INSTRUCTIONS

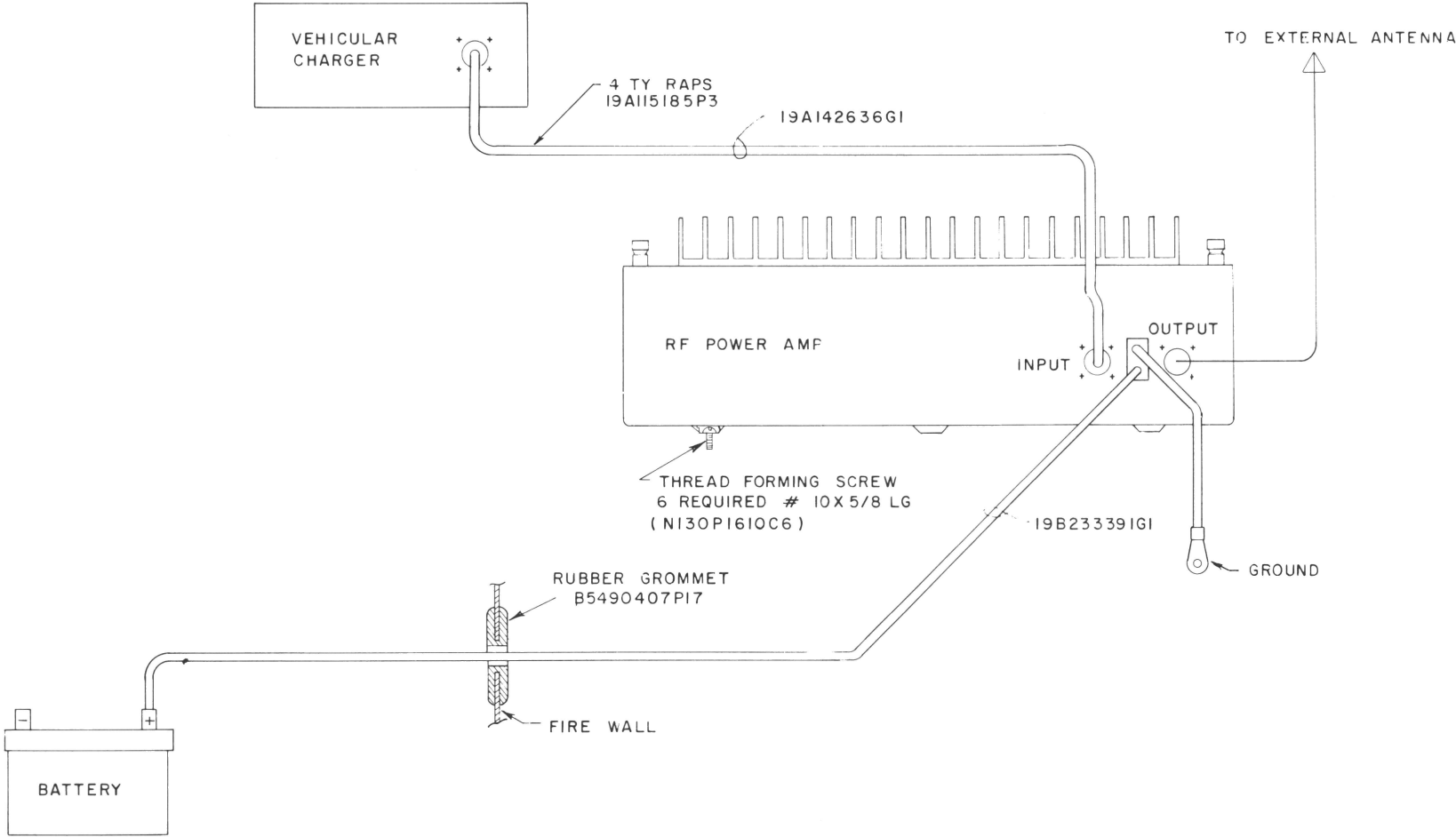
The Vehicular Power Amplifier can be mounted on any flat surface. Simply disassemble the housing as shown in the Disassembly Procedure. Use the U shaped base plate as a mounting bracket. Fasten the bracket in the desired location using the hardware shown in the installation drawing. Re-assemble the amplifier. Route and connect all cables also shown in the installation drawing.



Base Plate Mounting Bracket



External Connections



(19C330416, Rev. 1)

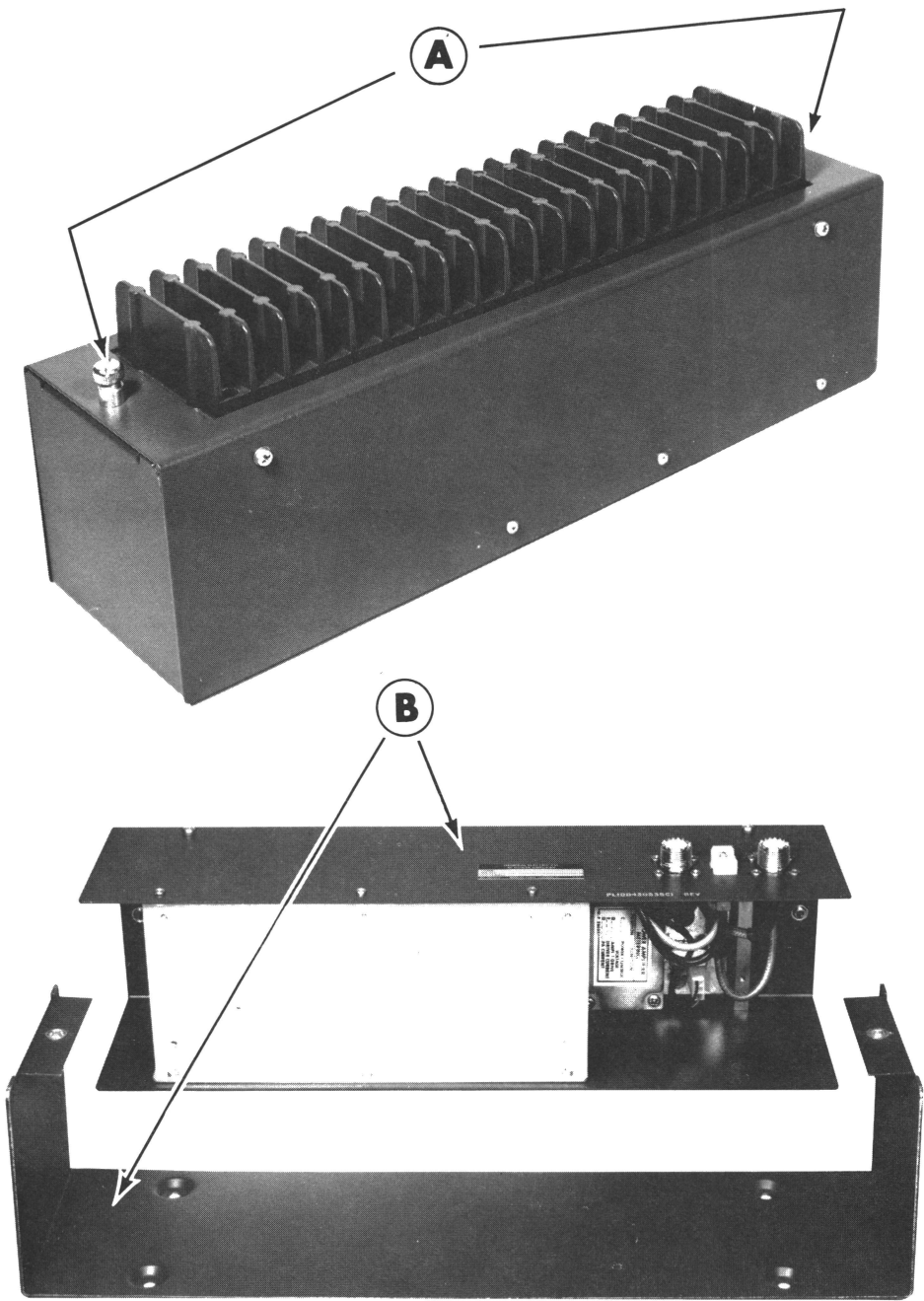
INSTALLATION INSTRUCTIONS

VEHICULAR POWER AMPLIFIER

DISASSEMBLY PROCEDURE

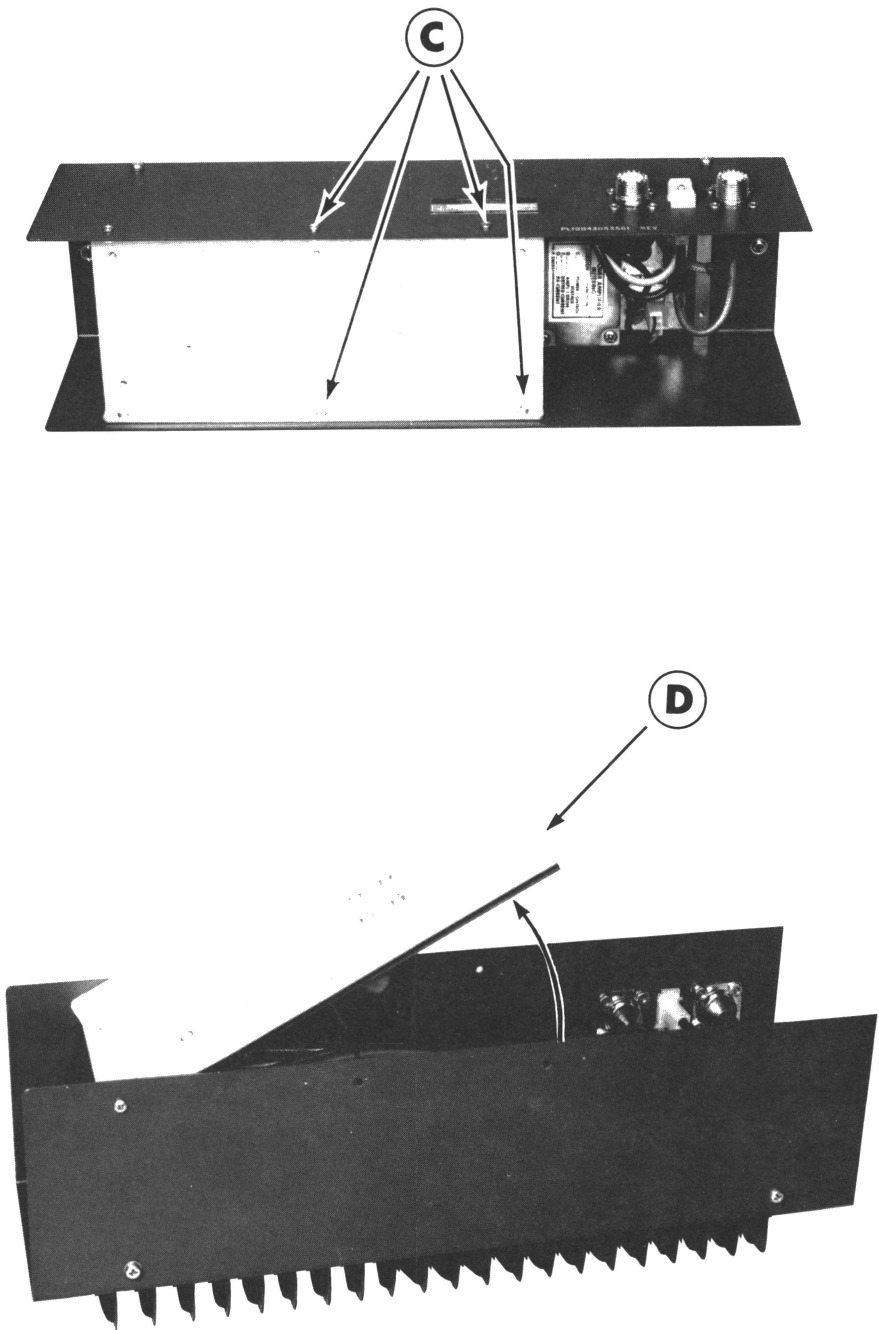
STEP 1

To gain access to the Vehicular Power Amplifier, loosen the cap-  
sive screws at (A) and separate the housing as shown at (B).



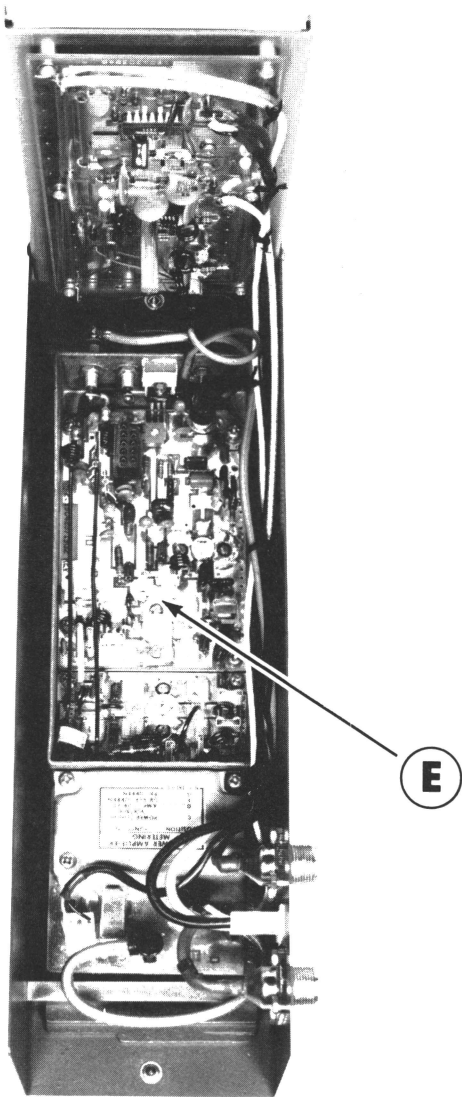
STEP 2

To gain access to the Interface Board or the Final  
Power Amplifier, remove the four Phillips-Head screws  
at (C) and swing open the cover plate as shown at (D).



STEP 3

To gain access to the Final Power Circuitry remove the  
snap on cover to expose the circuitry as shown at (E).



DISASSEMBLY PROCEDURE

VEHICULAR POWER AMPLIFIER

PA POWER INPUT

For FCC purposes, the PA power input can be determined by measuring the PA supply voltage and PA current using the following formula:

$P_i = \text{PA voltage} \times \text{PA current}$

where:

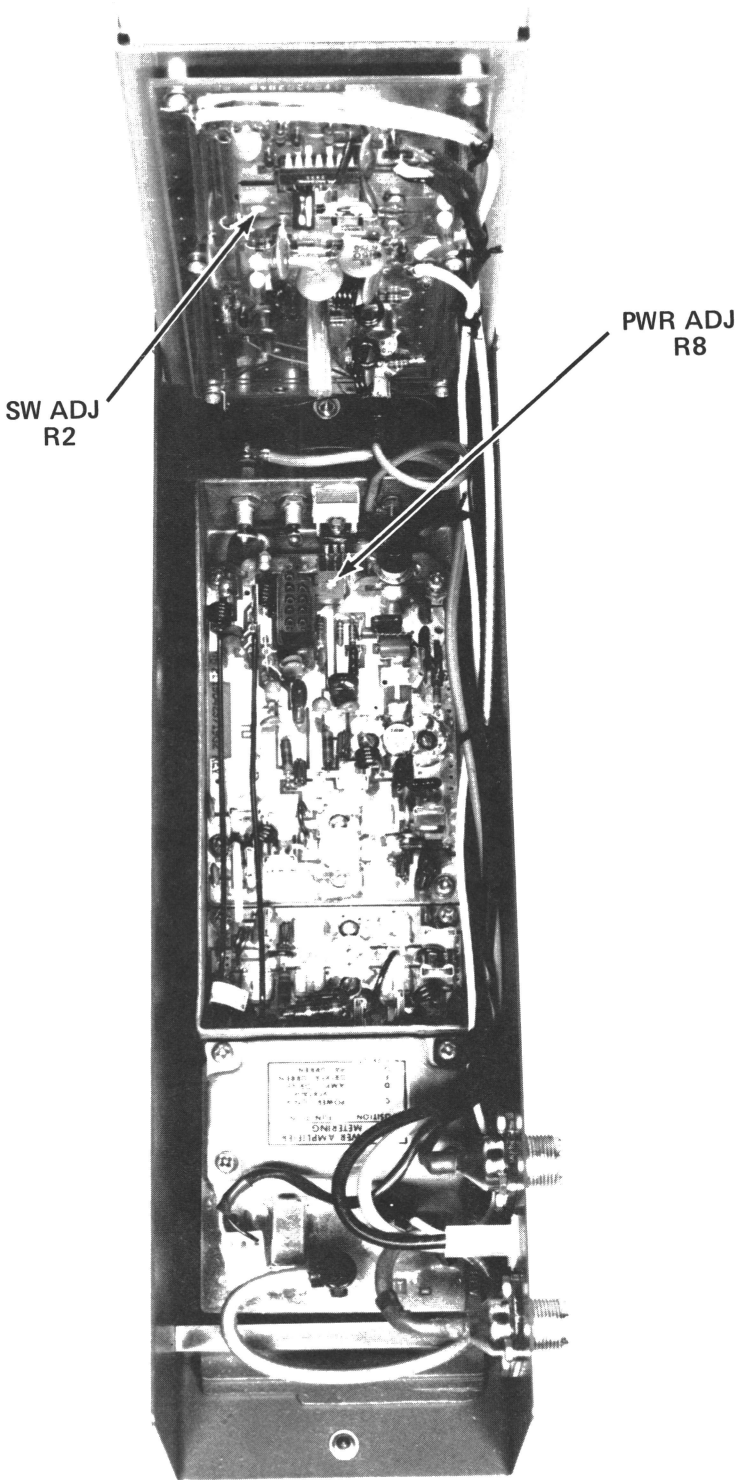
$P_i$  is the power input in watts.

PA voltage is measured according to the Note in Step 4 of the Adjustment Procedure.

PA current is measured with the Test Set in Positions G and Test 1. Read 15 amperes full scale with the HIGH SENSITIVITY button pressed.

Example:

$P_i = 12.6 \text{ Volts} \times 4.5 \text{ Amperes} = 56.7 \text{ Watts}$



POWER AMPLIFIER ADJUSTMENT PROCEDURE  
(KT-183-A)

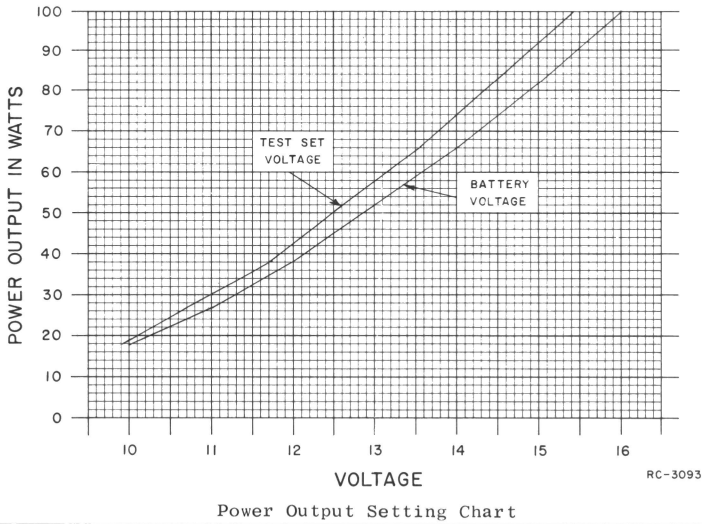
EQUIPMENT

- 1. GE Test Set Model 4EX3A11 or Test Kit Model 4EX8K12.
- 2. A 50 ohm wattmeter connected to J201.
- 3. An RF Signal Generator (Wavetek 2001 or equivalent) connected to J101.

PROCEDURE

STEP	TUNING CONTROL	PROCEDURE
Interface Board		
1	R2	Set switch adjust control R2 fully clockwise.
2	--	With the RF signal Generator, apply 0.5 Watts at 150 MHz ±1 MHz.
3	R2	While measuring the voltage on Pin 5 of U1, adjust R2 until the voltage switches from high (≈9 VDC) to low (≈1 VDC).
Final PA		
4	R8	<p>With the battery voltage at 13.6 Volts or the PA collector voltage at 13.0 Volts, set Power Adjust Control R8 on the PA board for desired power output.</p> <p>If the battery voltage is not at 13.6 Volts or the collector voltage is not at 13 Volts and full rated power output is desired, set R8 for the output power according to the battery voltage or collector voltage shown in the following chart.</p> <p>NOTE: PA voltage is measured with Test Set 4EX3A11 in position G. Read on the 15 Volt range as 15 Volts full scale with the polarity switch in the (-) position. With Test Set 4EX8K12, use the B+ position and the 1- Volt range. Read as 15 Volts full scale with the HIGH SENSITIVITY button pressed and the polarity switch in the (-) position.</p>

60 WATT EXECUTIVE II  
POWER OUTPUT VS VOLTAGE



ADJUSTMENT PROCEDURE

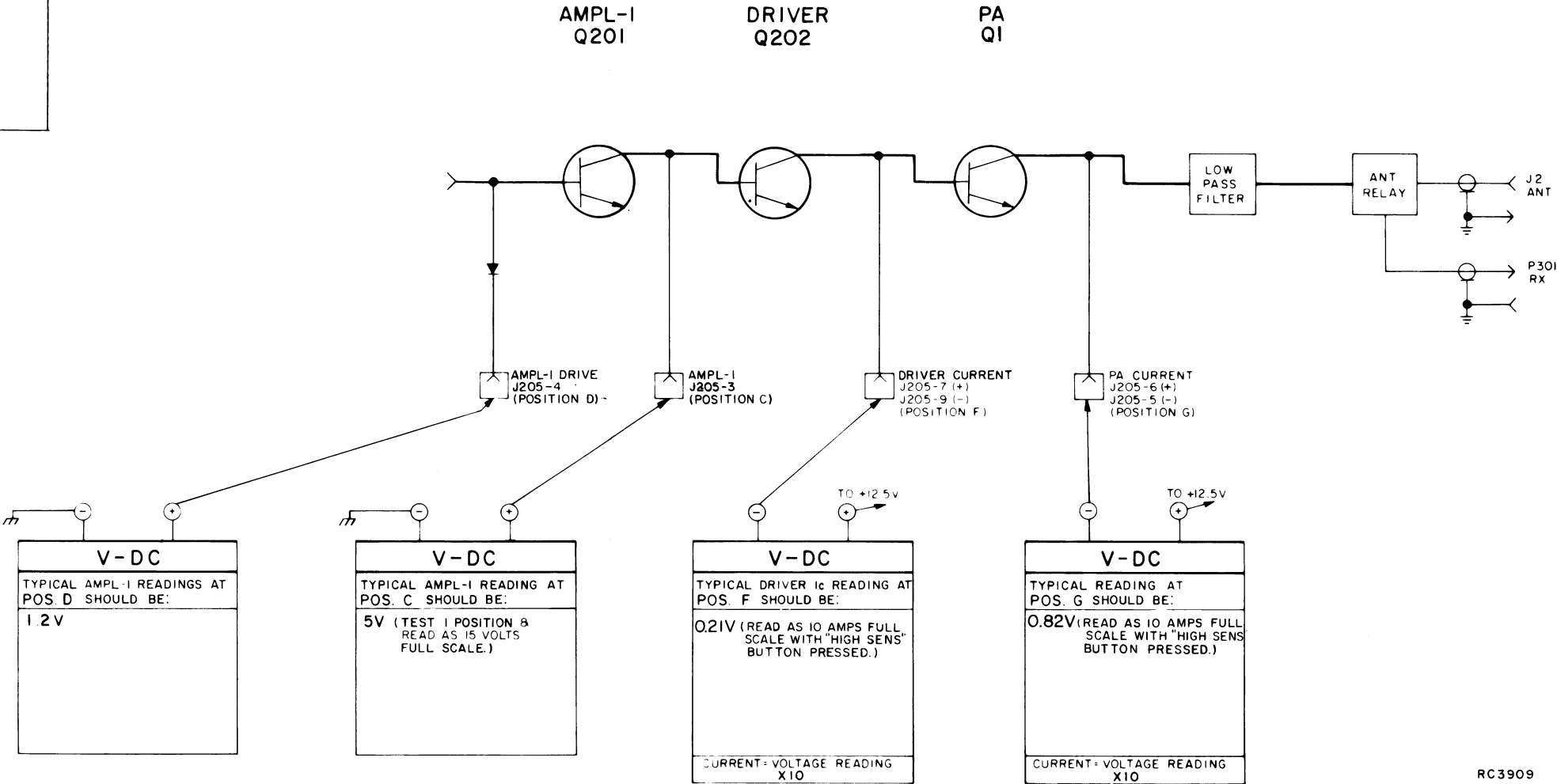
VEHICULAR POWER AMPLIFIER  
(KT183A)

STEP 1 - QUICK CHECKS

SYMPTOM	PROCEDURE
Low or No Power Output	1. Using Test Set Model 4EX3A11 in position D, check for drive to the final power amplifier. If a typical reading of 1.2V is present, go to the Quick Checks for the POWER AMPLIFIER. If a typical reading is not present, continue to the next step.
	2. Listen for transmit relay to close. A. Check for 10 VDC at H2. B. Check for <1 VDC at H3. C. Voltage at Pin 2 of U1 should increase with RF applied.
	3. Check for 10 VDC at emitter of Q2. A. Replace Q2. B. Replace VR1.
	4. Check amplifier transistor Q1 and associated components. A. Look for DC voltage at the collector of Q1. B. Check voltage drop across R12. C. Look for obvious component failures. D. Replace Q1.
	5. Check attenuator AT1. Should be <200 ohms from input to output (DC continuity).

POWER AMPLIFIER  
(SYMPTOMS LOW OR NO POWER OUTPUT)

METER POSITION GE TEST SET	PROBABLE DEFECTIVE STAGE		
	HIGH METER READING	LOW METER READING	ZERO METER READING
"D" (AMPL-1 DRIVE)		Low Output from Interface Board	No output from CR1 Interface Board
"C" (AMPL-1 POWER CONTROL VOLTAGE)	Q215	Q215	No Exciter output, Q215, CR1
"F" (DRIVER CURRENT)	Q1, Q202	Q202, Low Output from Q201	Q202, Q201. Check Pos. D & C
"G" (PA CURRENT)	Q1	Q201, Q202, Q1	Q1, Q202, Q201, Q215



STEP 2

CHECK TYPICAL DC VOLTAGES

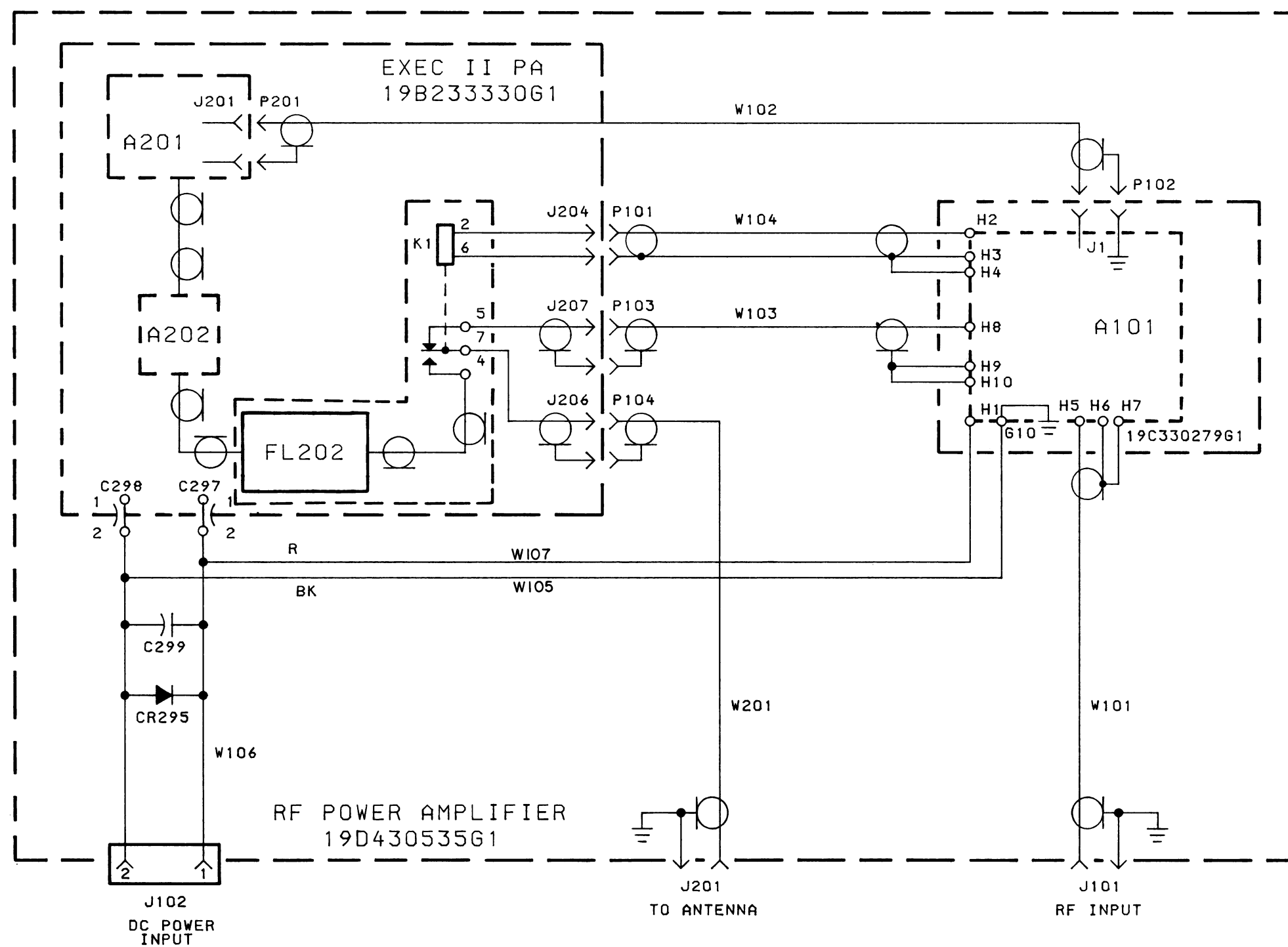
EQUIPMENT REQUIRED

- G.E. TEST MODEL 4EX3A11 OR
- 20,000 OHM-PER-VOLT METER

NOTE: ALL DC READINGS TAKEN WITH THE TRANSMITTER KEYED

TROUBLESHOOTING PROCEDURE

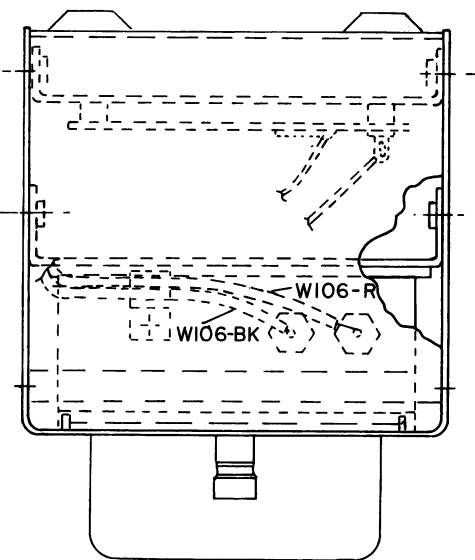
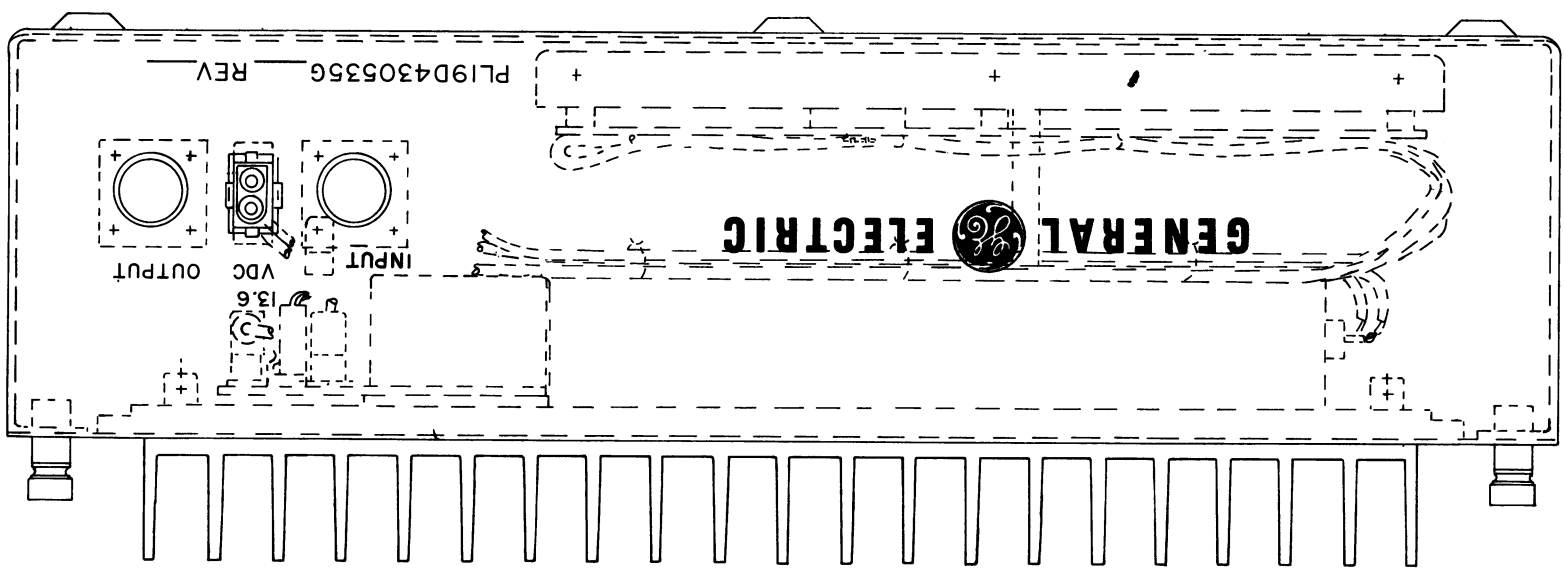
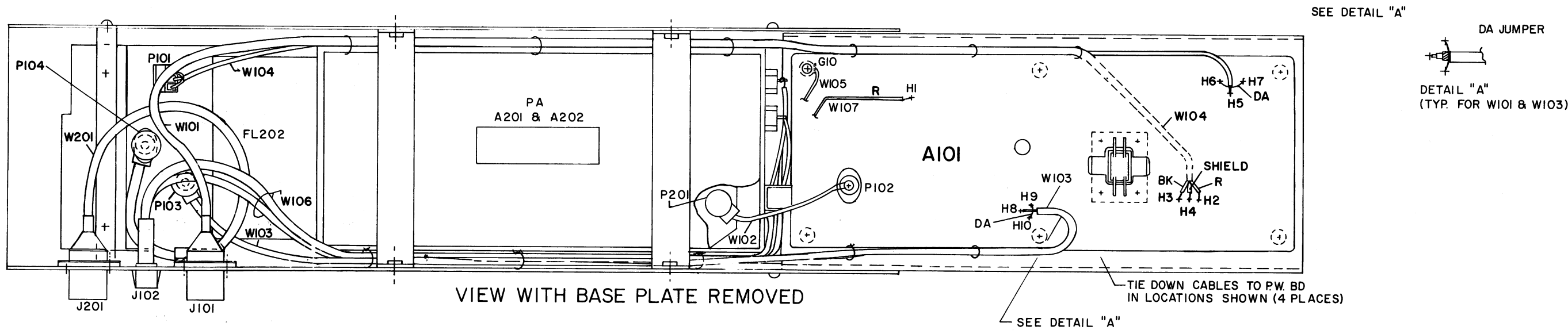
VEHICULAR POWER AMPLIFIER  
(KT183A)



(19C330415, Rev. 2)

### INTERCONNECTION DIAGRAM

VEHICULAR POWER AMPLIFIER  
(TYPE KT183A)

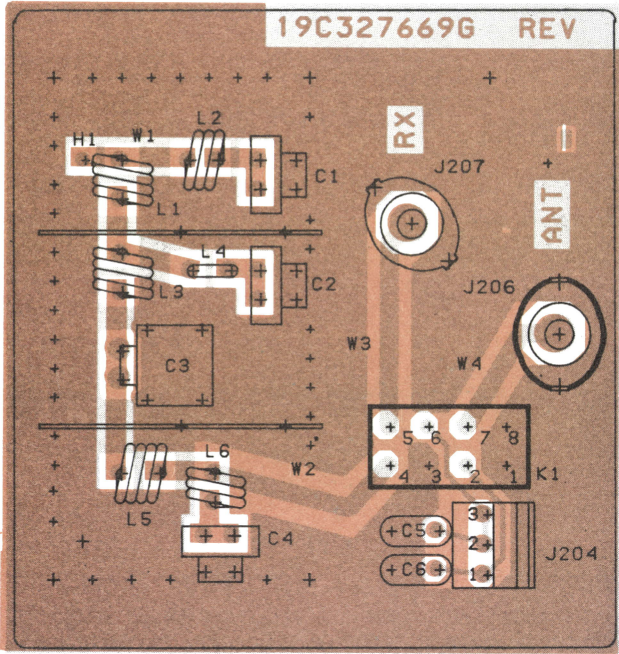


(19D430968, Rev. 1)

OUTLINE DIAGRAM

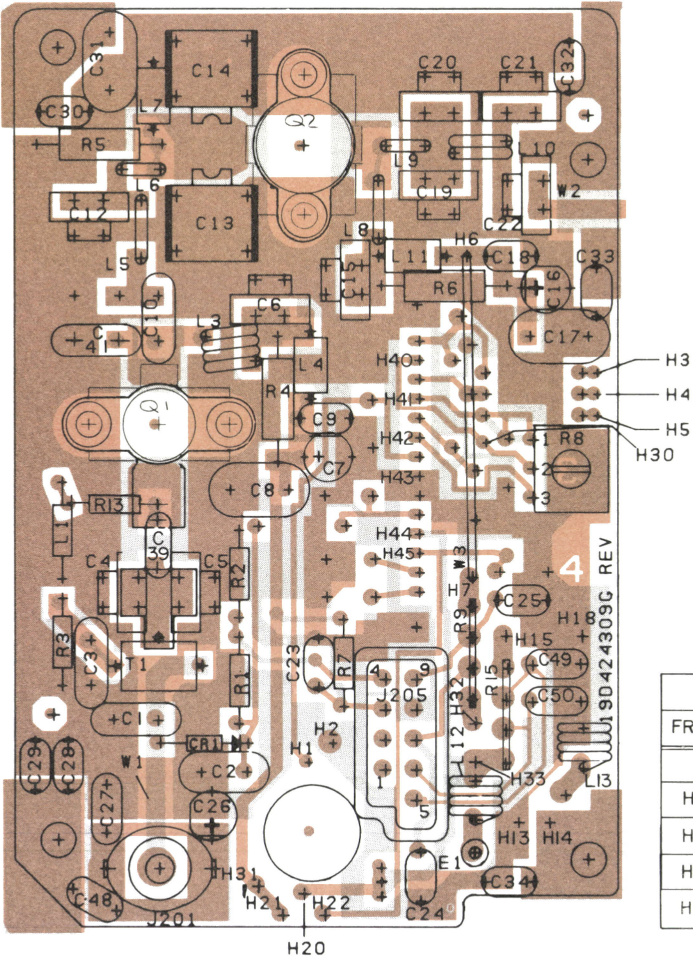
VEHICULAR POWER AMPLIFIER

FL202



(19C327916, Rev. 0)  
(19B227884, Sh. 1, Rev. 0)  
(19B227884, Sh. 2, Rev. 0)

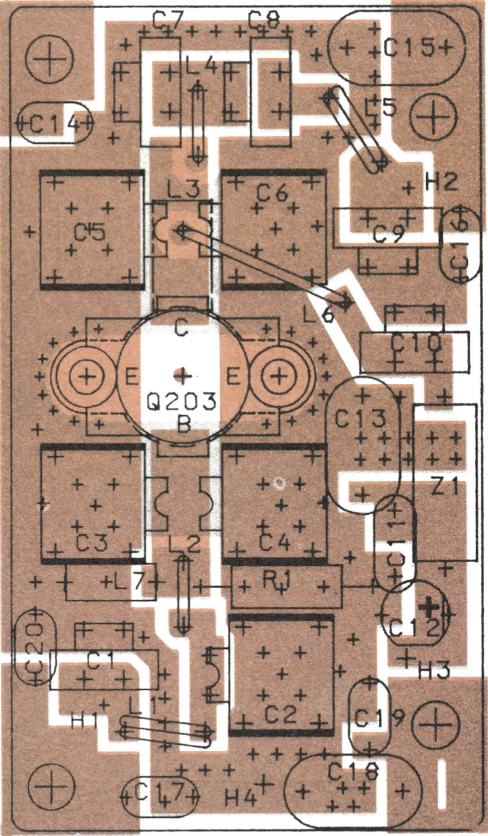
A201



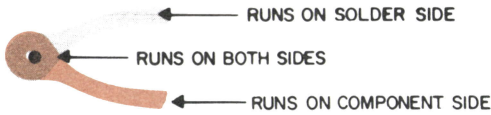
(19C330469, Rev. 1)  
(19B227634, Sh. 1, Rev. 4)  
(19B227634, Sh. 2, Rev. 3)

CONNECTIONS CHART			
FROM	TO	WIRE SIZE	REMARKS
H40	H45	DA	SLEEVE
H41	H43	DA	SLEEVE
H42	H44	DA	SLEEVE
H32	H33	DB	

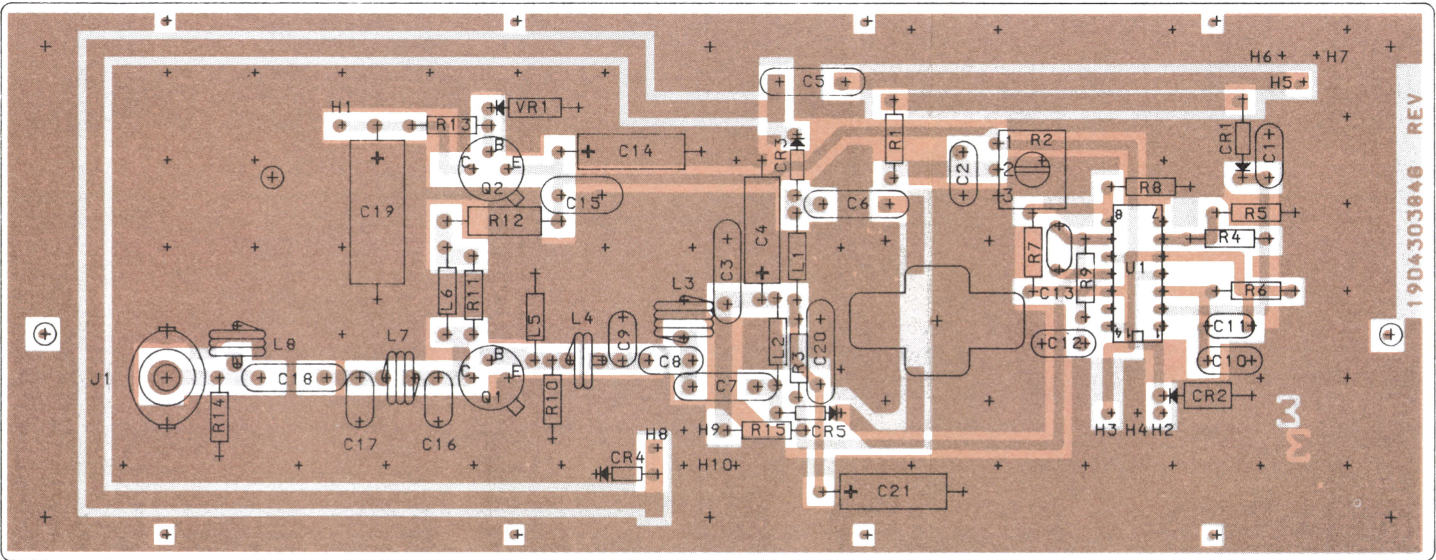
A202



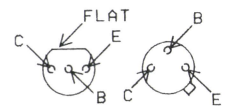
(19C327373, Rev. 3)  
(19B227346, Sh. 1, Rev. 1)  
(19B227346, Sh. 2, Rev. 1)



INTERFACE BOARD  
A101



LEAD IDENTIFICATION  
FOR Q1 & Q2



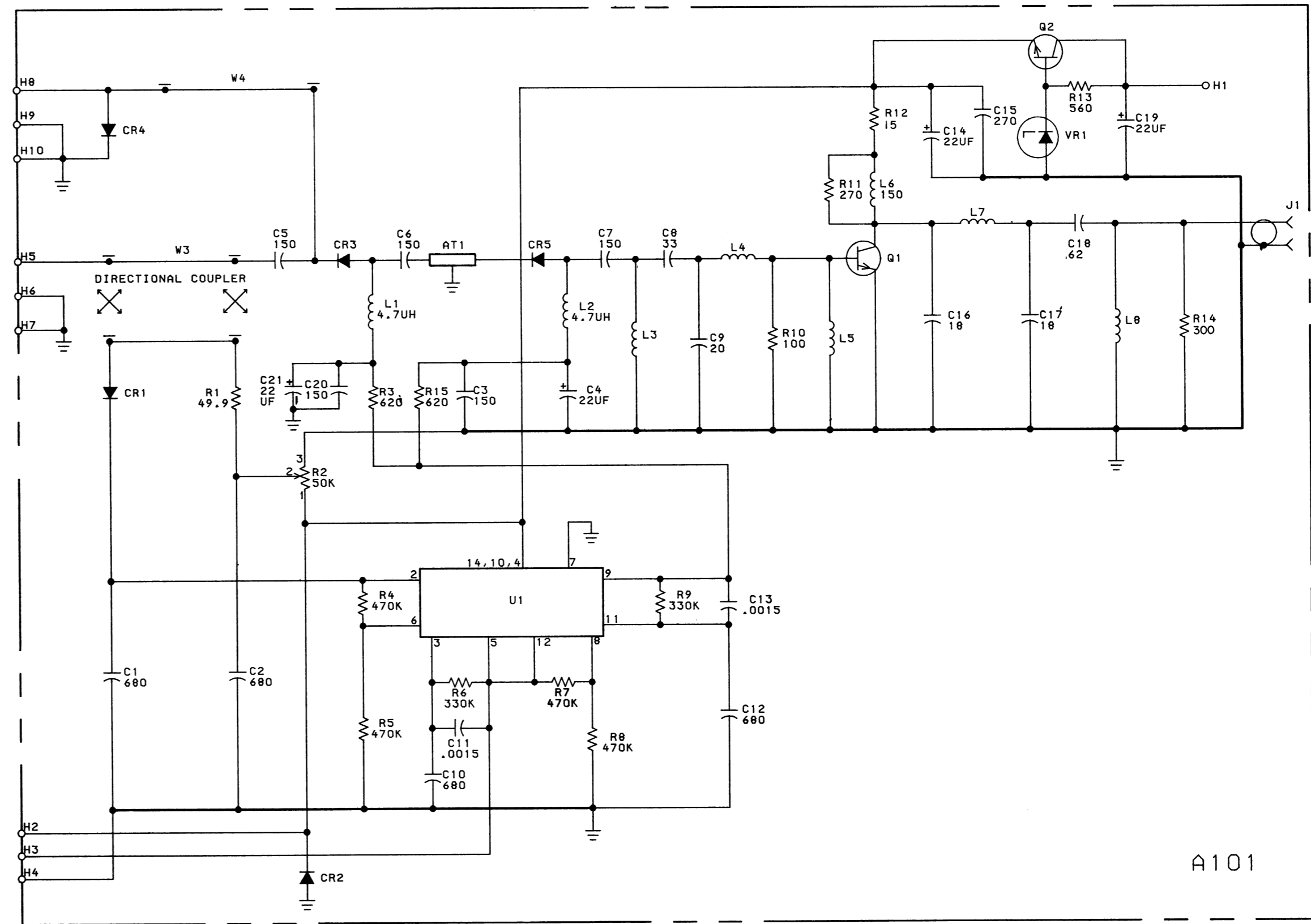
IN-LINE  
TOP VIEW

NOTE: LEAD ARRANGEMENT, AND NOT  
CASE SHAPE, IS DETERMINING  
FACTOR FOR LEAD IDENTIFICATION.

OUTLINE DIAGRAMS

VEHICULAR POWER AMPLIFIER

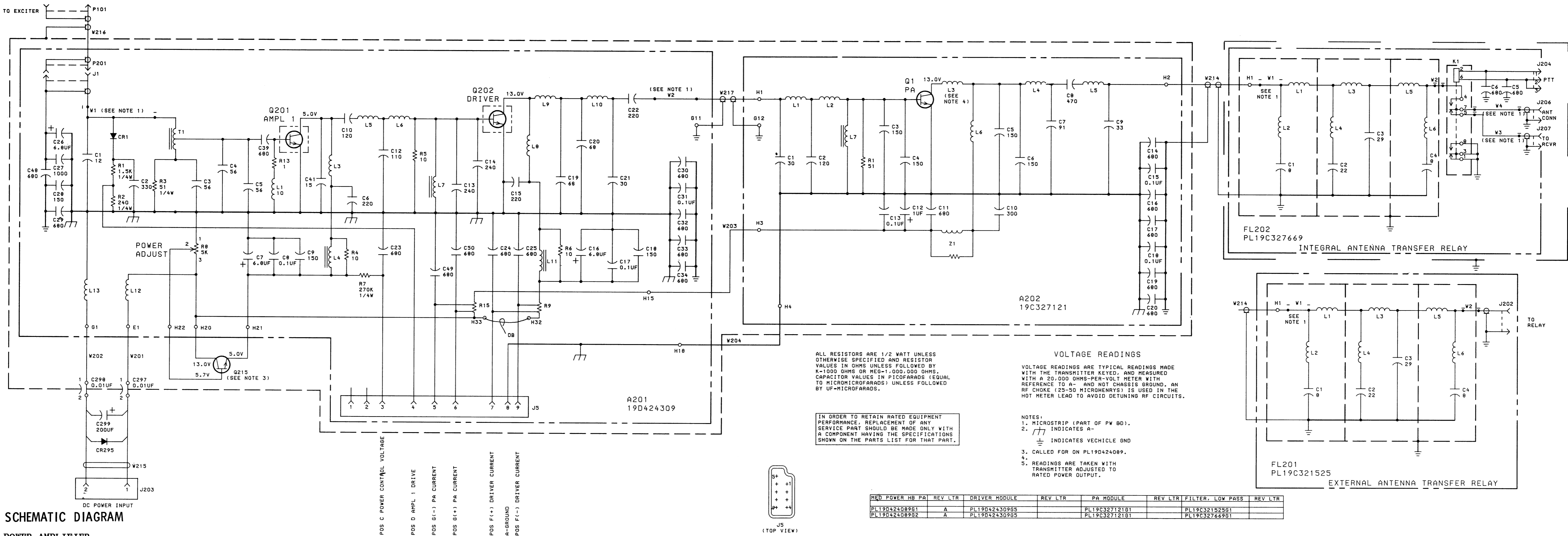
(19D430385, Rev. 4)  
(19A138499, Sh. 1, Rev. 3)  
(19A138499, Sh. 2, Rev. 3)



ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF=MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH=MILLIHENRYS OR H=HENRYS.

SCHEMATIC DIAGRAM

INTERFACE BAORD  
19D430384G1



SCHEMATIC DIAGRAM

POWER AMPLIFIER  
19B233330G1

PARTS LIST			SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
VHF RF POWER AMPLIFIER 19D430535G1 (KT-183-A) ISSUE 2											
SYMBOL	GE PART NO.	DESCRIPTION									
W102	19A130909G1	----- CABLES ----- Cable. Includes P102 & P201.	C18	19A116656P62J0	Ceramic disc: 62 pf ±5%, 500 VDCw, temp coef 0 PPM.	W101	19A142634G1	----- CABLES ----- CABLE ASSEMBLY 19A142634G1	C30	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.
			C19	5496267P19	Tantalum: 22 µf ±20%, 35 VDCw; sim to Sprague Type 150D.			C31	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCw.	
W106		CABLE ASSEMBLY 19B233332G1	C20	19A116656P150J0	Ceramic disc: 150 pf ±5%, 500 VDCw, temp coef 0 PPM.	J101	19A700067P1	----- JACKS AND RECEPTACLES ----- Connector. Includes: Receptacle, coaxial: sim to Amphenol 83-798 or Equiv. Military SO-239A.	C32 thru C36	19A116655P18	Ceramic disc: 380 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.
			C21	5496267P10	Tantalum: 22 µf ±20%, 15 VDCw; sim to Sprague Type 150D.			Cover.	CR1	19A115250P1	----- DIODES AND RECTIFIERS ----- Silicon, fast recovery, 225 ma, 50 PIV.
J102	19A134281P2 19A134282P4 7117269P1	----- JACKS AND RECEPTACLES ----- Connector. Includes: Shell. Contact, electrical: wire size No. 14-10; sim to AMP 350201-2. Terminal, solderless. (Located on opposite end of cable from connector).	CR1	19A116052P2	Hot carrier: Fwd. drop .410 volts max.	W103	19B209044P13	Cable, RF: sim to Essex 421-105.	E1 and E2	19A134263P1	----- TERMINALS ----- Contact, electrical; sim to Selectro X-L-070174-1.
			CR2	4037822P1	Silicon, 1000 ma, 400 PIV.			Cable. Includes P103.	J1	19A130924G1	----- JACKS AND RECEPTACLES ----- Connector, coaxial: jack type; sim to Cinch 14H11613.
W201		CABLE ASSEMBLY 19A129312G8	CR3 thru CR5	19A116925P1	Silicon, pin: 35 volt Reverse Breakdown, 400 mW.	W104	5491689P136	Cable. Includes P103.	J5	19B219374G1	Connector: 9 contacts.
			J1	19A130924G1	----- JACKS AND RECEPTACLES ----- Connector, receptacle: coaxial, jack type; sim to Cinch 14H11613.	P101	19A116659P14 19A116781P6	----- PLUGS ----- Connector. Includes: Shell. Contact, electrical: wire range No. 22-26 AWG; sim to Molex 05-50-0136.	L1	19A700024P25	----- INDUCTORS ----- Coil, RF: 10.0 µh ±10%, 3.70 ohms DC res max. (Part of printed board 19D423718P1).
J201	4029493P1 4029082P2	----- JACKS AND RECEPTACLES ----- Connector. Includes: Receptacle, coaxial: sim to Amphenol 83-798 or Equiv. Military SO-239A. Cover.	L1 and L2	19A700024P21	Coil, RF: 4.7 µh ±10%, 1.20 ohms DC res max.	A201*		POWER AMPLIFIER 19B233330G1 (19D424089G2)	L2	19A136530P1	Coil.
			L3	19C320617P5	Coil.				L3	19A129773G1	Coil.
P104	5491689P122	----- PLUGS ----- Plug. (Includes approx 10 inch cable).	L4	19A129355P2	Coil.	C1	19A116656P12J0	POWER AMPLIFIER MODULE 19D423719G2 (Deleted by REV A)	L4	19A136532P1	Coil.
			L5	19A700024P23	Coil, RF: 6.8 µh ±10%, 2.00 ohms DC res max.	----- CAPACITORS ----- Ceramic disc: 12 pf ±5%, 500 VDCw, temp coef 0 PPM.	L5	19A129575P1	Coil.		
A101		PRINTED WIRE BOARD SUPPORT 19C30279G1 INTERFACE BOARD 19D430384G1	L6	19B209420P103	Coil, RF: 0.15 µh ±10%, 0.10 ohms DC res max; sim to Jeffers 4416-3K.	C2	7489162P39	Silver mica: 330 pf ±5%, 500 VDCw; sim to Electro Motive Type DM-15.	L6	19A129773G1	Coil.
			L7	19A129352P1	Coil.				L7	19A136531P2	Coil.
C1 and C2	19A116655P18	----- CAPACITORS ----- Ceramic disc: 680 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.	L8	19C320617P25	Coil.	C3	19A700105P28	Mica: 56 pf ±5%, 500 VDCw.	L8	19A129575P1	Coil.
			Q1	19A116868P1	Silicon, NPN; sim to Type 2N4427.	C4	19A700015P30	Metallized teflon: 110 pf ±5%, 250 VDCw.	L9	19A136533P1	Coil.
C3	19A116656P150J0	Ceramic disc: 150 pf ±5%, 500 VDCw, temp coef 0 PPM.	Q2	19A115300P2	Silicon, NPN; sim to Type 2N3053.	C6	19A700015P37	Metallized teflon: 220 pf ±5%, 250 VDCw.	L11	19A129773G1	Coil.
C4	5496267P10	Tantalum: 22 µf ±20%, 15 VDCw; sim to Sprague Type 150D.				C7	19A134202P15	Tantalum: 6.8 µf ±20%, 35 VDCw.	L12 and L13	19A129569P1	Coil.
C5 thru C7	19A116656P150J0	Ceramic disc: 150 pf ±5%, 500 VDCw, temp coef 0 PPM.	R1	19A701250P68	Metal film: 49.9 ohms ±1%, 1/4 w.	C8	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCw.	R1	19A700106P61	Composition: 820 ohms ±5%, 1/4 w.
C8	5496218P351	Ceramic disc: 33 pf ±5%, 500 VDCw, temp coef -150 PPM.	R2	19A116559P108	Variable, cermet: 50K ohms ±20%, 0.5 w; sim to CTS Series 360.	C9	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.		19A700106P49	Composition: 270 ohms ±5%, 1/4 w.
C9	19A116656P20J0	Ceramic disc: 20 pf ±5%, 500 VDCw, temp coef 0 PPM.	R3	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.	C10	19A700105P34	Mica: 100 pf ±5%, 500 VDCw.	R2	19A700106P32	Composition: 51 ohms ±5%, 1/4 w.
C10	19A116355P18	Ceramic disc: 680 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.	R4 and R5	3R152P474J	Composition: 470K ohms ±5%, 1/4 w.	C11	19A700105P14	Mica: 18 pf ±5%, 500 VDCw.	R3	19A700113P15	Composition: 10 ohms ±5%, 1/2 w.
C11	19A700005P2	Polyester: 15 pf ±10%, 50 VDCw.	R6	3R152P334J	Composition: 330K ohms ±5%, 1/4 w.	C12	19A700015P30	Metallized teflon: 110 pf ±5%, 250 VDCw.	R4 thru R6	3R152P274J	Composition: 270K ohms ±5%, 1/4 w.
C12	19A116655P13	Ceramic disc: 680 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.	R7 and R8	3R152P474J	Composition: 470K ohms ±5%, 1/4 w.	C13 and C14	19A700014P38	Metallized teflon: 240 pf ±5%, 250 VDCw.		19A116559P102	Variable, cermet: 5K ohms ±20%, .5 w; sim to CTS Series 360.
C13	19A700005P2	Polyester: 15 pf ±10%, 50 VDCw.	R9	3R152P334J	Composition: 330K ohms ±5%, 1/4 w.	C15	19A116679P470K	Mica: 470 pf ±10%, 250 VDCw.	R9 and R10	19C320212P2	Shunt resistor.
C14	5496267P10	Tantalum: 22 µf ±20%, 15 VDCw; sim to Sprague Type 150D.	R10	19A700106P39	Composition: 100 ohms ±5%, 1/4 w.	C16	19A134202P15	Tantalum: 6.8 µf ±20%, 35 VDCw.	T1	19A129564G1	----- TRANSFORMERS ----- Transformer.
C15	19A700105P46	Mica: 270 pf ±5%, 500 VDCw.	R11	3R152P271J	Composition: 270 ohms ±5%, 1/4 w.	C17	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCw.		W1	A201*
C16 and C17	19A116656P18J0	Ceramic disc: 18 pf ±5%, 500 VDCw, temp coef 0 PPM.	R12	19A700113P19	Composition: 15 ohms ±5%, 1/2 w.	C18	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.	POWER AMPLIFIER MODULE 19D424309G5 (Added by REV A)		
			R13	3R152P121J	Composition: 120 ohms ±5%, 1/4 w.	C19 and C20	19A700015P25	Teflon/mica: 68 pf ±5%, 250 VDCw.	C1A	19A700105P8	----- CAPACITORS ----- Mica: 12 pf ±5%, 500 VDCw.
			R14	3R152P301J	Composition: 300 ohms ±5%, 1/4 w.	C21	19A700015P16	Teflon/mica: 30 pf ±5%, 250 VDCw.		7489162P39	Silver mica: 330 pf ±5%, 500 VDCw; sim to Electro Motive Type DM-15.
			R15	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.	C22	19A700015P37	Metallized teflon: 220 pf ±5%, 250 VDCw.	C2	19A700105P28	Mica: 56 pf ±5%, 500 VDCw.
			U1	19A116968P3	Linear, timer: 14 Pin Dip Package; sim to Signetics SA556N.	C23 thru C25	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.		19A700015P23	Metallized teflon: 56 pf ±5%, 250 VDCw.
			VR1	4036887P8	Zener: 500 mW, 11.0 v. nominal.	C26	19A134202P15	Tantalum: 6.8 µf ±20%, 35 VDCw.	C4A and C5A		
			AT1	19B233367G1	Attenuator.	C27	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCw; sim to RMC Type JF Discap.			
						C28	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.			
						C29	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCw; sim to RMC Type JF Discap.			

Cont' on page 14

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
C6	19A700015P37	Metallized teflon: 220 pf ±5%, 250 VDCW.	L11	19A129773G1	Coil.	R1	19A700113P32	----- RESISTORS ----- Composition: 51 ohms ±5%, 1/2 w.	w201	19B227024P1	----- CABLES ----- Jumper.
C7	19A134202P15	Tantalum: 6.8 µf ±20%, 35 VDCW.	L12	19A129569P1	Coil.			----- NETWORKS ----- FILTER ASSEMBLY 19B219049G1	w202	19B227025G1	Jumper.
C8	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	L13		----- RESISTORS -----	41			w203	19B227484P2	Jumper.
C9	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	R1	19A700106P67	Composition: 1.5K ohms ±5%, 1/4 w.			----- INDUCTORS -----	w204	19B227484P1	Jumper.
C10B	19A700105P36	Mica: 120 pf ±5%, 500 VDCW.	R2	3R152P241J	Composition: 240 ohms ±5%, 1/4 w.	L1	19A129346G2	Coil.	w214	19A130607G1	Cable, RF: approx 1 foot long.
C12	19A700015P30	Metallized teflon: 110 pf ±5%, 250 VDCW.	R3	19A700106P32	Composition: 51 ohms ±5%, 1/4 w.			----- RESISTORS ----- Composition: 10 ohms ±5%, 1/2 w.	w215	19B227058G1	Cable: approx 1 foot long.
C13B	19A700014P38	Metallized teflon: 240 pf ±5%, 250 VDCW.	R4	19A700113P15	Metallized teflon: 10 ohms ±5%, 1/2 w.	R1	3R78P100K	Composition: 10 ohms ±10%, 1 w.	w216	19A130909G1	Cable, RF: approx 7-1/2 inches long.
C14B	19A700014P38	Metallized teflon: 240 pf ±5%, 250 VDCW.	R5B and R6	19A700113P15	Metallized teflon: 10 ohms ±5%, 1/2 w.			----- CAPACITORS -----	w217	19A136529G2	Cable: approx 2 inches long.
C15	19A700015P37	Metallized teflon: 220 pf ±5%, 250 VDCW.	R7	3R152P274J	Composition: 270K ohms ±5%, 1/4 w.	C297 and C298	19A116708P1	Ceramic, feed-thru: 0.01 µf +100% -0%, 500 VDCW; sim to Erie Style 327.		19B233324G1	Base plate.
C16	19A134202P15	Tantalum: 6.8 µf ±20%, 35 VDCW.	R8B	19A116559P102	Variable, cermet: 5K ohms ±20%, 0.5 w; sim to CTS Series 360.	C299	19A115680P10	Electrolytic: 200 µf +150% -10%, 18 VDCW; sim to Mallory Type TTX.		19B233328G1	Cover.
C17	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	R9	19C320212P2	Shunt resistor.			----- DIODES AND RECTIFIERS ----- Rectifier, silicon: 100 VDC blocking, 6 amps.		4029851P6	Clip loop. (Secures w101, w103, w104, w106).
C18	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	R13	19A116216P1R0J	Deposited carbon: 1.0 ohms ±5%, 1/4 w; sim to Amperex Type B803104 Style CR25.	CR295	19A116783P1	----- FILTERS ----- COMPONENT BOARD 19C327689G1		19A121759P1	Thumbscrew. (Secures Cover).
C19	19A700015P25	Mica: 68 pf ±5%, 250 VDCW.	R15	19C320212P2	Shunt resistor.			----- CAPACITORS -----		4033714P11	Terminal, solderless. (Located at G10).
C20B	19A700015P25	Metallized teflon: 68 pf ±5%, 250 VDCW.	T1	19A129564G1	Coil.	FL202				19B233325G1	Support. (A101).
C21A	19A700015P16	Metallized teflon: 30 pf ±5%, 250 VDCW.	w1 and w2		----- CABLES ----- (Part of printed board 19D424308P1).	C1	19A116679P8D	Metallized teflon: 8 pf ±.5 pf, 250 VDCW.		19B233387G1	Attenuator. (AT1).
C22A	19A700015P37	Metallized teflon: 220 pf ±5%, 250 VDCW.	w3	19B227912P1	Jumper.	C2	19A700015P12	Metallized teflon: 22 pf ±5%, 250 VDCW.		4036555P1	Insulator, washer: nylon. (Used with Q1 & Q2 on A101).
C23 thru C25	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	A202		POWER AMPLIFIER MODULE 19C327121G1	C3	19A116795P29J	Silver mica: 29 pf ±5%, 250 VDCW; sim to Underwood Type J1HF.		19A142616P1	Spacer. (Secures heat sink to cover).
C26	19A134202P15	Tantalum: 6.8 µf ±20%, 35 VDCW.			----- CAPACITORS -----	C4	19A116679P8D	Metallized teflon: 8 pf ±.5 pf, 250 VDCW.		19C321591G4	Heat sink.
C27	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	C1	19A700015P16	Metallized teflon: 30 pf ±5%, 250 VDCW.	C5 and C6	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.		19D416275P3	Casting.
C28	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C2	19A116795P120J	Teflon/mica: 120 pf ±5%, 250 VDCW.	J204	19A116659P55	Connector, printed wiring: 3 contacts; sim to Molex 09-65-1031.		19C327282P1	Insulator. (Located under A201).
C29 and C30	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C3 thru C6	19A700014P33	Metallized teflon: 150 pf ±5%, 250 VDCW.	J206 and J207	19A130924G1	Connector, receptacle: jack type; sim to Cinch 14H11613.		19A129434P1	Washer. (Located on C297 & C298).
		----- DIODES AND RECTIFIERS -----	C7	19A700015P28	Metallized teflon: 91 pf ±5%, 250 VDCW.			----- RELAYS ----- Hermetic sealed: 180 to 341 ohms coil res, 8-16.3 VDC; sim to GE 3SAV1760A2, CP Clare HFW-1201558 or Potter-Brumfield HCM6160.		7878455P2	Solderless terminal. (Located at G11 & G12).
		Silicon, fast recovery, 225 mA, 50 PIV.	C8	19A700015P45	Metallized teflon: 470 pf ±5%, 250 VDCW.	K1	19A700061P1			4029851P6	Clip loop. (Secures w215).
		----- TERMINALS -----	C9	19A700015P17	Metallized teflon: 33 pf ±5%, 250 VDCW.			----- INDUCTORS -----		19A130568P1	Plate. (Mounts Q215).
		Contact, electrical: sim to Selectro 229-1082-00-0-590.	C10	19A700015P40	Metallized teflon: 300 pf ±5%, 250 VDCW.	L1	19A129569P1	Coil.		19A116023P1	Insulator, plate. (Used with Q215).
E1	19A134263P1	Polyester: 0.1 µf ±10%, 50 VDCW.	C11	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	L2	19A129570P1	Coil.		19A134016P1	Insulator, bushing. (Used with Q215).
G1	19A134263P1	Contact, electrical: sim to Selectro 229-1082-00-0-590.	C12	19A134202P14	Tantalum: 1 µf ±20%, 35 VDCW.	L3	19A129569P1	Coil.		M4P9006C6	Machine screw: No. 4-40 x 3/8. (Secures Q201-Q203).
		----- JACKS AND RECEPTACLES -----	C13	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	L4	19A129575P1	Coil.		19B201074P305	Tap screw, Phillips P04IDRIV®: No. 6-32 x 5/16. (Secures A201 & A202).
J201	19A130924G1	Connector, receptacle: coaxial, jack type; sim to Cinch 14H11613.	C14	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	L5	19A129569P1	Coil.		19B201074P312	Tap screw, Phillips P04IDRIV®: No. 6-32 x 3/4. (Secures filter casting).
J205	19B219374G1	Connector: 9 contacts.	C15	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	L6	19A129570P1	Coil.		7139898P3	Hex nut: 1/4-28. (Secures C297 & C298).
		----- INDUCTORS -----	C16 and C17	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	w1 thru w4		----- CABLES ----- (Part of printed board 19C327670P1).			
L1	19A700024P25	Coil, RF: 10.0 µh ±10%, 3.70 ohms DC res max.	C18	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.			----- TRANSISTORS -----			
L3A	19A136530P1	Coil.	C19 and C20	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	Q201	19A134340P1	Silicon, NPN.			
L4	19A129773G1	Coil.			----- INDUCTORS -----	Q202	19A134340P2	Silicon, NPN.			
L5B	19A136532P1	Coil.	L1	19A136713P1	Coil.	Q203	19A134387P1	Silicon, NPN, VHF Amplifier: 70 Watts, 12.5 v.			
L6	19A129575P1	Coil.	L2	19A136714P1	Coil.	Q215	19A116742P1	Silicon, NPN.			
L7	19A129773G1	Coil.	L3		(Part of printed board 19C327120P1).						
L8B	19A136531P1	Coil.	L4	19A136715P1	Coil.						
L9B	19A129575P1	Coil.	L5	19A136713P1	Coil.						
L10B	19A136533P1	Coil.	L6	19A136716P1	Coil.						
			L7	19A129773G1	Coil.						

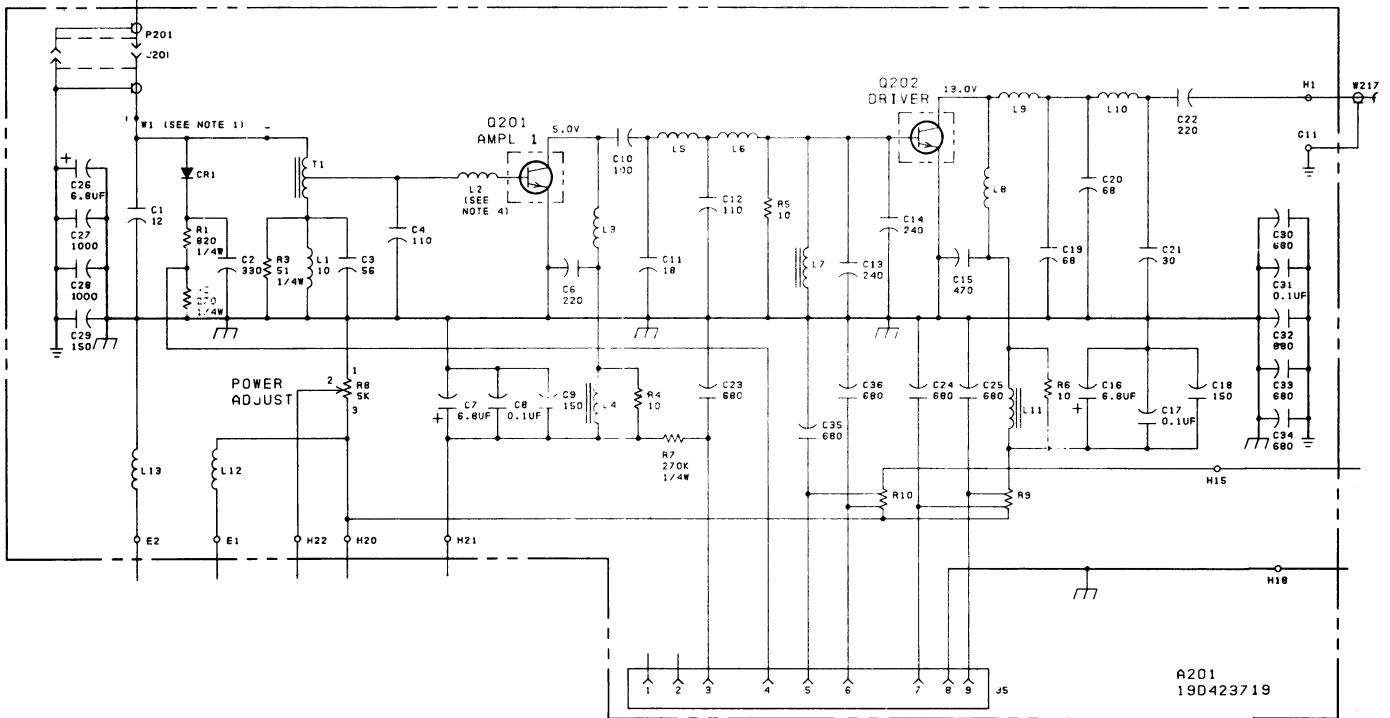
# PRODUCTION CHANGES

LBI30836

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - Power Amplifier 19D424089G2  
To incorporate a common printed wire board.  
Changed A201.

Outline Diagram was:



Schematic Diagram was:

